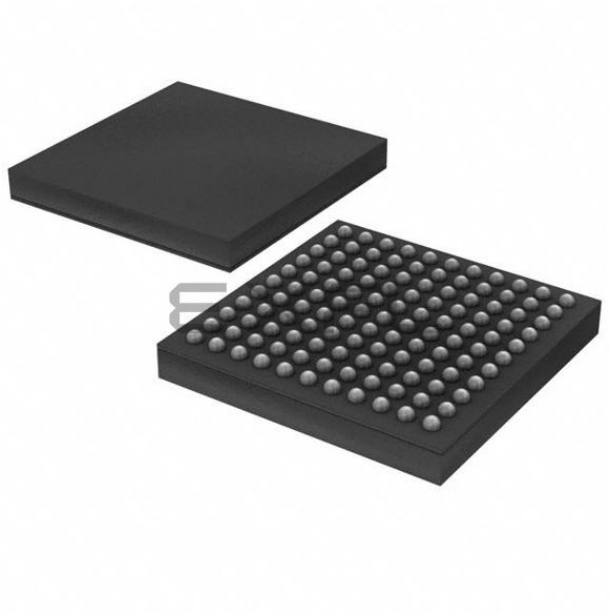

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	ARM® Cortex®-M3
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	EBI/EMI, I²C, IrDA, SmartCard, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	93
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.98V ~ 3.8V
Data Converters	A/D 8x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	120-VFBGA
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32lg395f64-bga120t

3.2.10 EFM32LG390

The features of the EFM32LG390 is a subset of the feature set described in the EFM32LG Reference Manual. The following table describes device specific implementation of the features.

EFM32LG390 Configuration Summary

Table 3.10. 230 Configuration Summary

Module	Configuration	Pin Connections
Cortex-M3	Full configuration	NA
DBG	Full configuration	DBG_SWCLK, DBG_SWDIO, DBG_SWO
MSC	Full configuration	NA
DMA	Full configuration	NA
RMU	Full configuration	NA
EMU	Full configuration	NA
CMU	Full configuration	CMU_OUT0, CMU_OUT1
WDOG	Full configuration	NA
PRS	Full configuration	NA
USB	Full configuration	USB_VBUS, USB_VBUSEN, USB_VREGI, USB_VREGO, USB_DM, USB_DMPU, USB_DP, USB_ID
EBI	Full configuration	EBI_A[27:0], EBI_AD[15:0], EBI_ARDY, EBI_ALE, EBI_BL[1:0], EBI_CS[3:0], EBI_CSTFT, EBI_DCLK, EBI_DTEN, EBI_HSNC, EBI_NANDREn, EBI_NANDWEn, EBI_REn, EBI_VSNC, EBI_WEn
I2C0	Full configuration	I2C0_SDA, I2C0_SCL
I2C1	Full configuration	I2C1_SDA, I2C1_SCL
USART0	Full configuration with IrDA	US0_TX, US0_RX. US0_CLK, US0_CS
USART1	Full configuration with I2S	US1_TX, US1_RX, US1_CLK, US1_CS
USART2	Full configuration with I2S	US2_TX, US2_RX, US2_CLK, US2_CS
UART0	Full configuration	U0_TX, U0_RX
UART1	Full configuration	U1_TX, U1_RX
LEUART0	Full configuration	LEU0_TX, LEU0_RX
LEUART1	Full configuration	LEU1_TX, LEU1_RX
TIMER0	Full configuration with DTI	TIM0_CC[2:0], TIM0_CDTI[2:0]
TIMER1	Full configuration	TIM1_CC[2:0]
TIMER2	Full configuration	TIM2_CC[2:0]
TIMER3	Full configuration	TIM3_CC[2:0]
RTC	Full configuration	NA
BURTC	Full configuration	NA
LETIMER0	Full configuration	LET0_O[1:0]
PCNT0	Full configuration, 16-bit count register	PCNT0_S[1:0]
PCNT1	Full configuration, 8-bit count register	PCNT1_S[1:0]

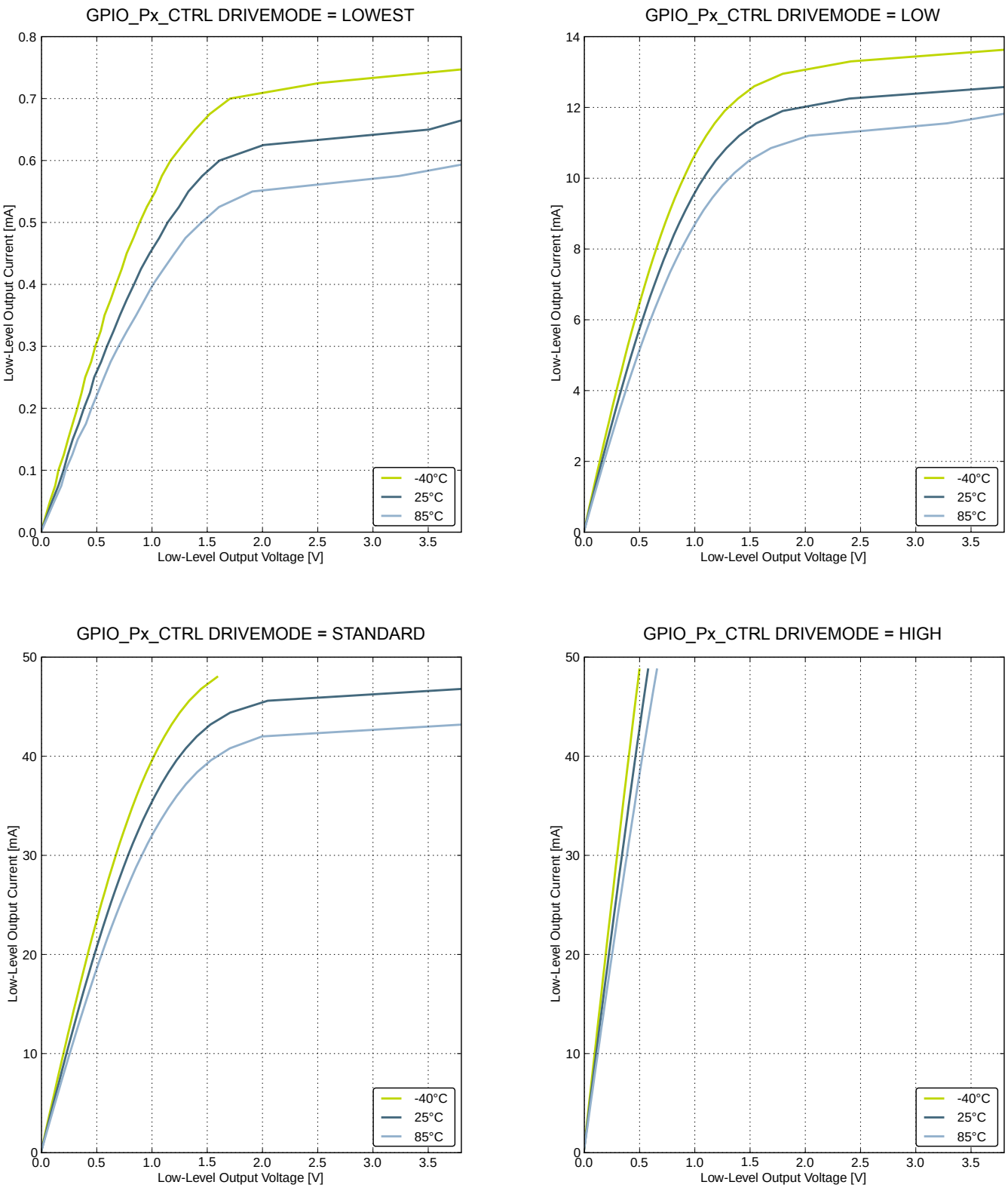

Figure 4.14. Typical Low-Level Output Current, 3.8 V Supply Voltage

4.9.4 HFRCO

Table 4.11. HFRCO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Oscillation frequency, all packages except CSP, V_{DD}= 3.0 V, T_{AMB}=25°C	f_{HFRCO}	f_{HFRCO} = 28 MHz	27.5	28.0	28.5	MHz
		f_{HFRCO} = 21 MHz	20.6	21.0	21.4	MHz
		f_{HFRCO} = 14 MHz	13.7	14.0	14.3	MHz
		f_{HFRCO} = 11 MHz	10.8	11.0	11.2	MHz
		f_{HFRCO} = 6.6 MHz	6.48[1]	6.6[1]	6.72[1]	MHz
		f_{HFRCO} = 1.2 MHz	1.15[2]	1.2[2]	1.25[2]	MHz
Oscillation frequency, all packages except CSP, over full supply and temperature range	f_{HFRCO}	f_{HFRCO} = 28 MHz	24.9	28.0	31.1	MHz
		f_{HFRCO} = 21 MHz	18.8	21.0	23.3	MHz
		f_{HFRCO} = 14 MHz	12.4	14.0	15.6	MHz
		f_{HFRCO} = 11 MHz	9.9	11.0	12.2	MHz
		f_{HFRCO} = 6.6 MHz	5.9[1]	6.6[1]	7.4[1]	MHz
		f_{HFRCO} = 1.2 MHz	0.8[2]	1.2[2]	1.6[2]	MHz
Oscillation frequency, CSP devices, V_{DD}= 3.0 V, T_{AMB}=25°C	f_{HFRCO}	f_{HFRCO} = 28 MHz	—	28.0	—	MHz
		f_{HFRCO} = 21 MHz	—	21.0	—	MHz
		f_{HFRCO} = 14 MHz	—	14.0	—	MHz
		f_{HFRCO} = 11 MHz	—	11.0	—	MHz
		f_{HFRCO} = 6.6 MHz	—	6.6[1]	—	MHz
		f_{HFRCO} = 1.2 MHz	—	1.2[2]	—	MHz
Oscillation frequency, CSP devices, over full supply and temperature range	f_{HFRCO}	f_{HFRCO} = 28 MHz	—	28.0	—	MHz
		f_{HFRCO} = 21 MHz	—	21.0	—	MHz
		f_{HFRCO} = 14 MHz	—	14.0	—	MHz
		f_{HFRCO} = 11 MHz	—	11.0	—	MHz
		f_{HFRCO} = 6.6 MHz	—	6.6[1]	—	MHz
		f_{HFRCO} = 1.2 MHz	—	1.2[2]	—	MHz
Settling time after start-up	$t_{HFRCO\_settling}$	f_{HFRCO} = 14 MHz	—	0.6	—	Cycles
Current consumption	I_{HFRCO}	f_{HFRCO} = 28 MHz	—	165	215	µA
		f_{HFRCO} = 21 MHz	—	134	175	µA
		f_{HFRCO} = 14 MHz	—	106	140	µA
		f_{HFRCO} = 11 MHz	—	94	125	µA
		f_{HFRCO} = 6.6 MHz	—	77	105	µA
		f_{HFRCO} = 1.2 MHz	—	25	40	µA

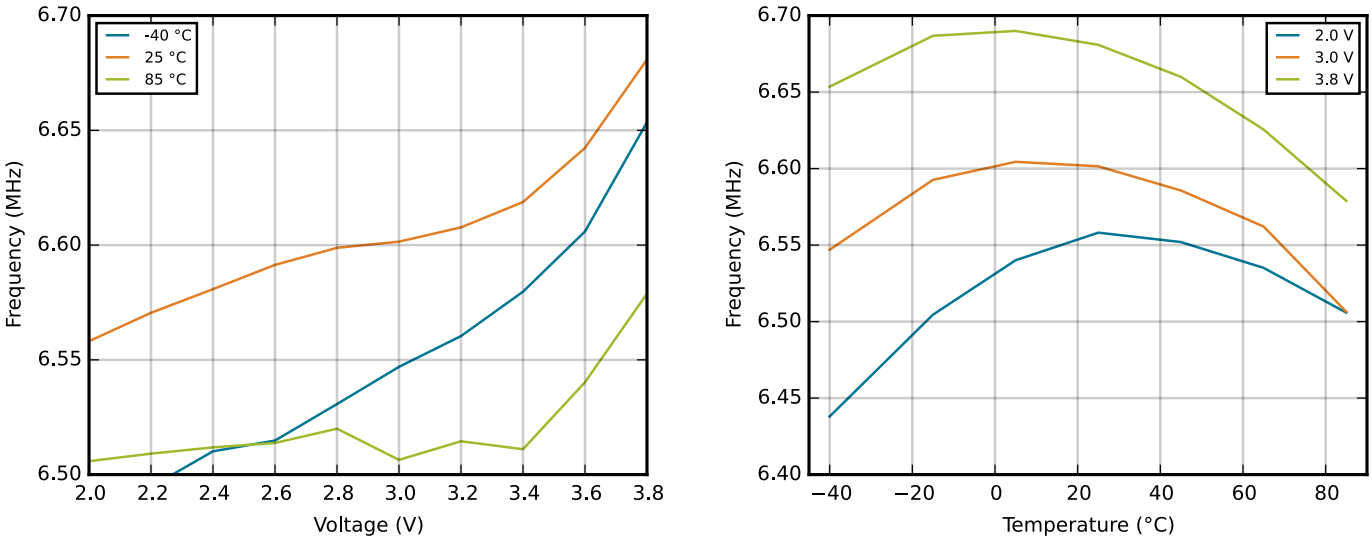

Figure 4.18. Calibrated HFRCO 7 MHz Band Frequency vs Supply Voltage and Temperature

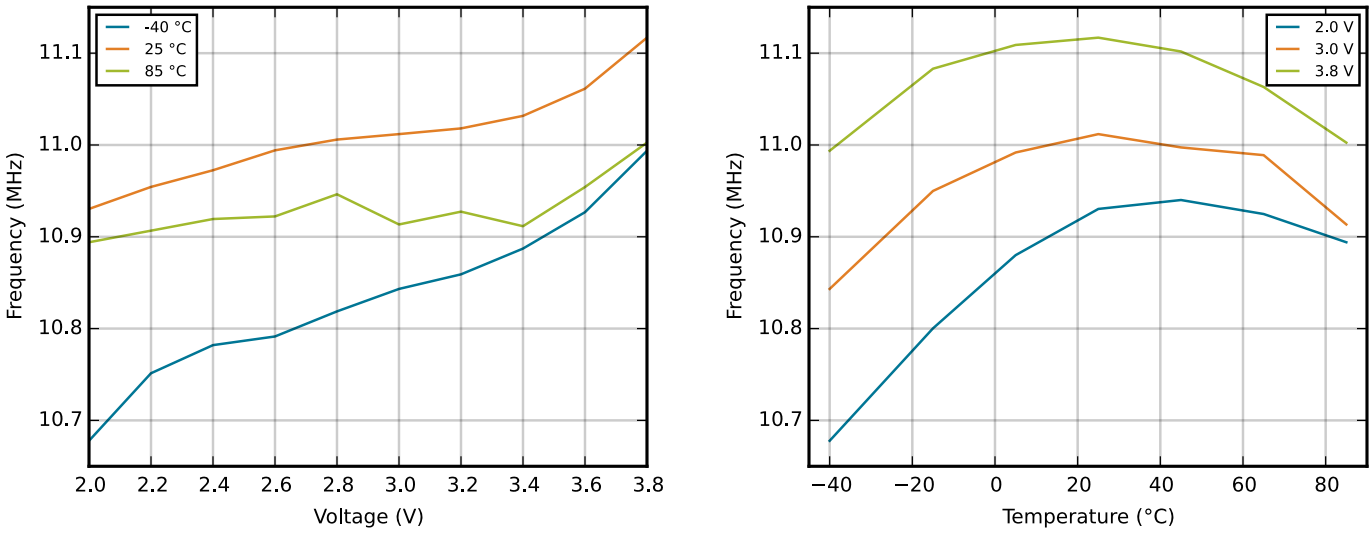

Figure 4.19. Calibrated HFRCO 11 MHz Band Frequency vs Supply Voltage and Temperature

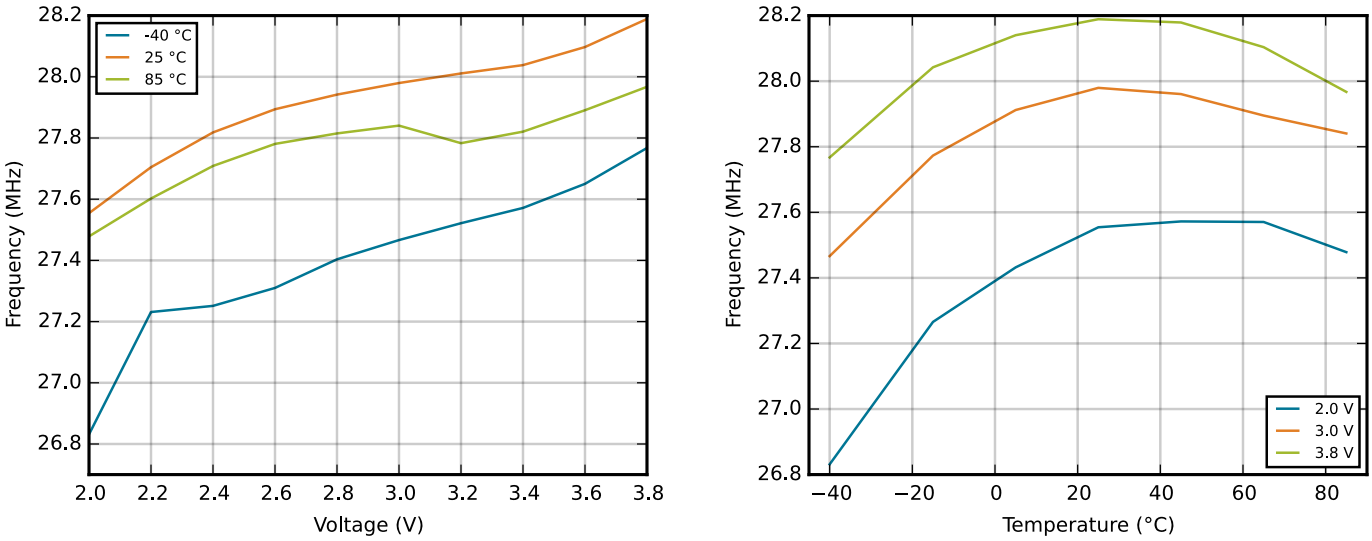

Figure 4.22. Calibrated HFRCO 28 MHz Band Frequency vs Supply Voltage and Temperature

4.9.5 AUXHFRCO

Table 4.12. AUXHFRCO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Oscillation frequency, all packages except CSP, V_{DD}= 3.0 V, T_{AMB}=25°C	$f_{AUXHFRCO}$	28 MHz frequency band	27.5	28.0	28.5	MHz
		21 MHz frequency band	20.6	21.0	21.4	MHz
		14 MHz frequency band	13.7	14.0	14.3	MHz
		11 MHz frequency band	10.8	11.0	11.2	MHz
		7 MHz frequency band	6.48[1]	6.60[1]	6.72[1]	MHz
		1 MHz frequency band	1.15[2]	1.20[2]	1.25[2]	MHz
Oscillation frequency, CSP devices, V_{DD}= 3.0 V, T_{AMB}=25°C	$f_{AUXHFRCO}$	28 MHz frequency band	—	28.0	—	MHz
		21 MHz frequency band	—	21.0	—	MHz
		14 MHz frequency band	—	14.0	—	MHz
		11 MHz frequency band	—	11.0	—	MHz
		7 MHz frequency band	—	6.60[1]	—	MHz
		1 MHz frequency band	—	1.20[2]	—	MHz
Settling time after start-up	$t_{AUXHFRCO\_settling}$	$f_{AUXHFRCO}$ = 14 MHz	—	0.6	—	Cycles
Frequency step for LSB change in TUNING value	$TUNESTEP_{AUXHFRCO}$		—	0.3[3]	—	%

Note:

1. For devices with prod. rev. < 19, Typ = 7MHz and Min/Max values not applicable.
2. For devices with prod. rev. < 19, Typ = 1MHz and Min/Max values not applicable.
3. The TUNING field in the CMU_AUXHFRCOCTRL register may be used to adjust the AUXHFRCO frequency. There is enough adjustment range to ensure that the frequency bands above 7 MHz will always have some overlap across supply voltage and temperature. By using a stable frequency reference such as the LFXO or HFXO, a firmware calibration routine can vary the TUNING bits and the frequency band to maintain the AUXHFRCO frequency at any arbitrary value between 7 MHz and 28 MHz across operating conditions.

4.9.6 ULFRCO

Table 4.13. ULFRCO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Oscillation frequency	f_{ULFRCO}	25°C, 3V	0.7	—	1.75	kHz
Temperature coefficient	TC_{ULFRCO}		—	0.05	—	%/°C
Supply voltage coefficient	VC_{ULFRCO}		—	-18.2	—	%/V

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Positive response time	$t_{RESPONSE\_P}$	BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=0	—	1014	—	ns
		BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=1	—	1671	—	ns
		BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=2	—	1786	—	ns
		BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=3	—	1933	—	ns
		BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=4	—	2046	—	ns
		BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=5	—	2262	—	ns
		BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=6	—	2531	—	ns
		BIASPROG=0b0100, FULLBIAS=0, HALFBIAS=1, Overdrive = 100 mV, LPREF=0, HYSTSEL=7	—	2907	—	ns
Offset voltage	$V_{ACMPOFFSET}$	BIASPROG= 0b1010, FULLBIAS=0 and HALFBIAS=0 in ACMPn_CTRL register	-12	0	12	mV
		BIASPROG= 0b0100, FULLBIAS=0, HALFBIAS=1, and LPREF=0 in ACMPn_CTRL register	-14.4	0.4	14.8	mV
		BIASPROG= 0b1111, FULLBIAS=0, HALFBIAS=1, and LPREF=0 in ACMPn_CTRL register	-13.3	0.3	13.2	mV

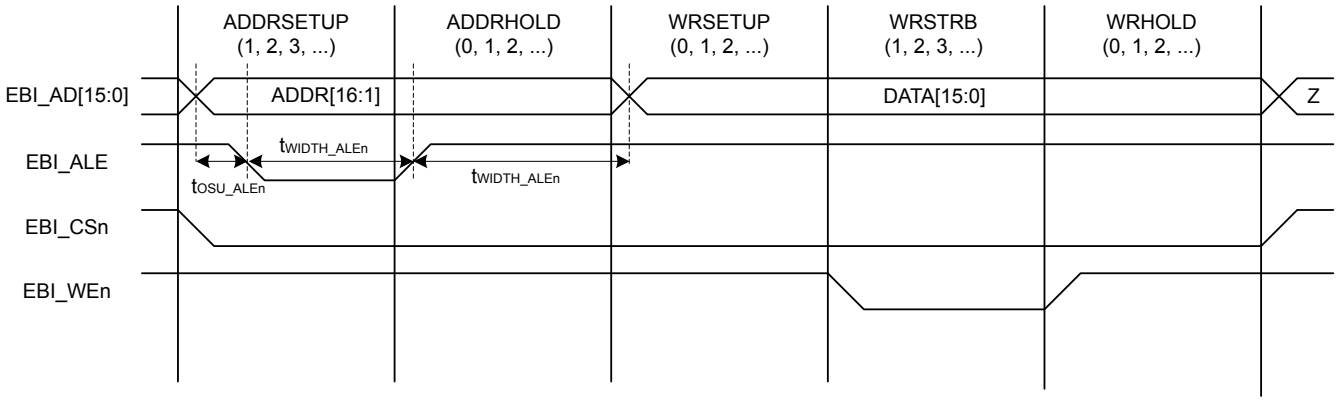

Figure 4.38. EBI Address Latch Enable Related Output Timing

Table 4.20. EBI Address Latch Enable Related Output Timing

Parameter	Symbol	Min	Typ	Max	Unit
Output hold time, from trailing EBI_ALE edge to EBI_AD invalid	t_{OH_ALEn} [1 2 3 4]	-6.00 + (WRHOLD[5] × $t_{HFCORECLK}$)	—	—	ns
Output setup time, from EBI_AD valid to leading EBI_ALE edge	t_{OSU_ALEn} [1 2 4]	-13.00 + (0 × $t_{HFCORECLK}$)	—	—	ns
EBI_ALEn pulse width	t_{WIDTH_ALEn} [1 2 3 4]	-7.00 + ((ADDRSETUP + 1) × $t_{HFCORECLK}$)	—	—	ns

Note:

1. Applies to addressing modes D8A24ALE and D16A16ALE (figure only shows D16A16ALE)
2. Applies for all polarities (figure only shows active low signals)
3. The figure shows the timing for the case that the half strobe length functionality is not used, i.e. HALFALE=0. The trailing edge of EBI_ALE can be moved to the left by setting HALFALE=1. This decreases the length of t_{WIDTH_ALEn} and increases the length of t_{OH_ALEn} by $t_{HFCORECLK}$ - 1/2 × $t_{HFCLKNODIV}$.
4. Measurement done at 10% and 90% of V_{DD} (figure shows 50% of V_{DD})
5. Figure only shows a write operation. For a multiplexed read operation the address hold time is controlled via the RDSETUP state instead of via the ADDRHOLD state.

5. Pin Definitions

Note: Please refer to the application note *AN0002 EFM32 Hardware Design Considerations* for guidelines on designing Printed Circuit Boards (PCBs) for the EFM32LG.

5.1 EFM32LG230 (QFN64)

5.1.1 Pinout

The EFM32LG230 pinout is shown in the following figure and table. Alternate locations are denoted by "#" followed by the location number (Multiple locations on the same pin are split with "/"). Alternate locations can be configured in the LOCATION bitfield in the *_ROUTE register in the module in question.

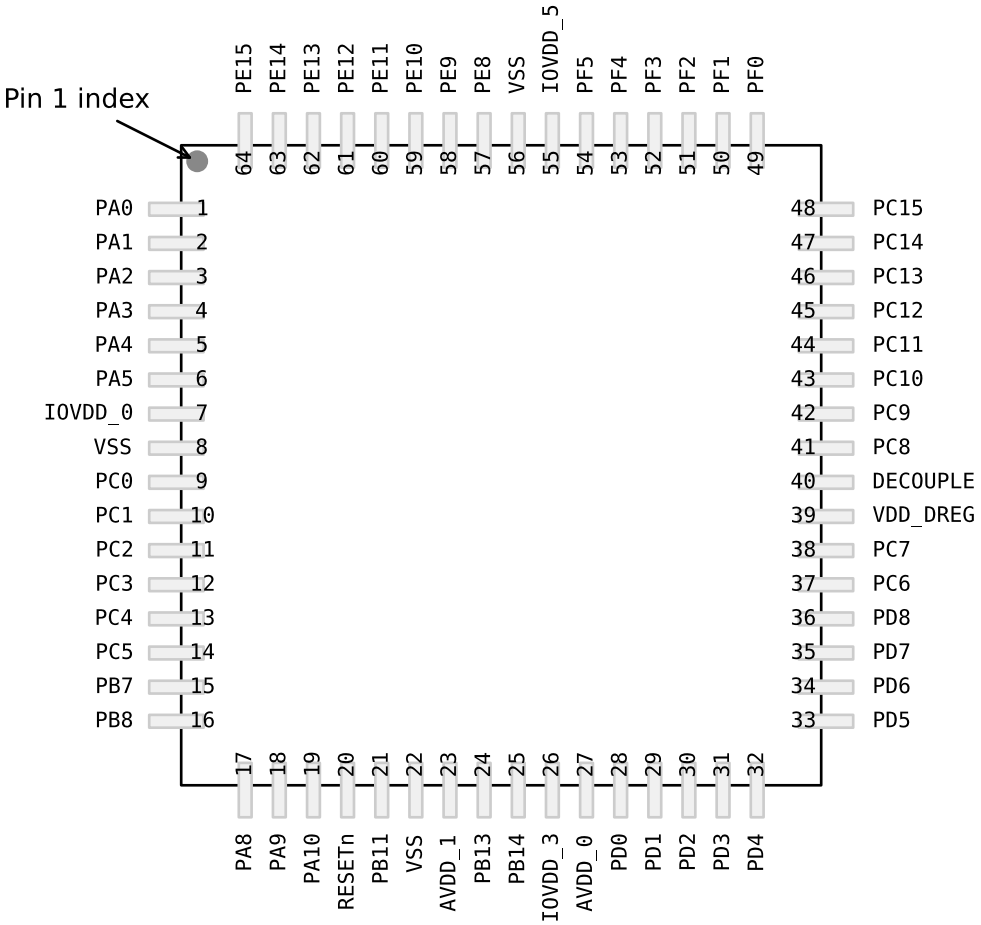

Figure 5.1. EFM32LG230 Pinout (top view, not to scale)

LQFP100 Pin# and Name		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	EBI	Timers	Communication	Other
26	PA7		EBI_CSTFT #0/1/2			
27	PA8		EBI_DCLK #0/1/2	TIM2_CC0 #0		
28	PA9		EBI_DTEN #0/1/2	TIM2_CC1 #0		
29	PA10		EBI_VSNC #0/1/2	TIM2_CC2 #0		
30	PA11		EBI_HSNC #0/1/2			
31	IOVDD_2	Digital IO power supply 2.				
32	VSS	Ground.				
33	PA12		EBI_A00 #0/1/2	TIM2_CC0 #1		
34	PA13		EBI_A01 #0/1/2	TIM2_CC1 #1		
35	PA14		EBI_A02 #0/1/2	TIM2_CC2 #1		
36	RESETn	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.				
37	PB9		EBI_A03 #0/1/2		U1_TX #2	
38	PB10		EBI_A04 #0/1/2		U1_RX #2	
39	PB11	DAC0_OUT0 / OPAMP_OUT0		TIM1_CC2 #3 LE-TIM0_OUT0 #1	I2C1_SDA #1	
40	PB12	DAC0_OUT1 / OPAMP_OUT1		LETIM0_OUT1 #1	I2C1_SCL #1	
41	AVDD_1	Analog power supply 1.				
42	PB13	HFXTAL_P			US0_CLK #4/5 LEU0_TX #1	
43	PB14	HFXTAL_N			US0_CS #4/5 LEU0_RX #1	
44	IOVDD_3	Digital IO power supply 3.				
45	AVDD_0	Analog power supply 0.				
46	PD0	ADC0_CH0 DAC0_OUT0ALT #4/ OPAMP_OUT0ALT OPAMP_OUT2 #1		PCNT2_S0IN #0	US1_TX #1	
47	PD1	ADC0_CH1 DAC0_OUT1ALT #4/ OPAMP_OUT1ALT		TIM0_CC0 #3 PCNT2_S1IN #0	US1_RX #1	DBG_SWO #2
48	PD2	ADC0_CH2	EBI_A27 #0/1/2	TIM0_CC1 #3	USB_DMPU #0 US1_CLK #1	DBG_SWO #3
49	PD3	ADC0_CH3 OPAMP_N2		TIM0_CC2 #3	US1_CS #1	ETM_TD1 #0/2
50	PD4	ADC0_CH4 OPAMP_P2			LEU0_TX #0	ETM_TD2 #0/2
51	PD5	ADC0_CH5 OPAMP_OUT2 #0			LEU0_RX #0	ETM_TD3 #0/2

5.4.2 Alternate Functionality Pinout

A wide selection of alternate functionality is available for multiplexing to various pins. This is shown in the following table. The table shows the name of the alternate functionality in the first column, followed by columns showing the possible LOCATION bitfield settings.

Note: Some functionality, such as analog interfaces, do not have alternate settings or a LOCATION bitfield. In these cases, the pinout is shown in the column corresponding to LOCATION 0.

Table 5.11. Alternate functionality overview

Alternate	LOCATION							
Functionality	0	1	2	3	4	5	6	Description
ACMP0_CH0	PC0							Analog comparator ACMP0, channel 0.
ACMP0_CH1	PC1							Analog comparator ACMP0, channel 1.
ACMP0_CH2	PC2							Analog comparator ACMP0, channel 2.
ACMP0_CH3	PC3							Analog comparator ACMP0, channel 3.
ACMP0_CH4	PC4							Analog comparator ACMP0, channel 4.
ACMP0_CH5	PC5							Analog comparator ACMP0, channel 5.
ACMP0_CH6	PC6							Analog comparator ACMP0, channel 6.
ACMP0_CH7	PC7							Analog comparator ACMP0, channel 7.
ACMP0_O	PE13	PE2	PD6					Analog comparator ACMP0, digital output.
ACMP1_CH0	PC8							Analog comparator ACMP1, channel 0.
ACMP1_CH1	PC9							Analog comparator ACMP1, channel 1.
ACMP1_CH2	PC10							Analog comparator ACMP1, channel 2.
ACMP1_CH3	PC11							Analog comparator ACMP1, channel 3.
ACMP1_CH4	PC12							Analog comparator ACMP1, channel 4.
ACMP1_CH5	PC13							Analog comparator ACMP1, channel 5.
ACMP1_CH6	PC14							Analog comparator ACMP1, channel 6.
ACMP1_CH7	PC15							Analog comparator ACMP1, channel 7.
ACMP1_O	PF2	PE3	PD7					Analog comparator ACMP1, digital output.
ADC0_CH0	PD0							Analog to digital converter ADC0, input channel number 0.
ADC0_CH1	PD1							Analog to digital converter ADC0, input channel number 1.
ADC0_CH2	PD2							Analog to digital converter ADC0, input channel number 2.
ADC0_CH3	PD3							Analog to digital converter ADC0, input channel number 3.
ADC0_CH4	PD4							Analog to digital converter ADC0, input channel number 4.
ADC0_CH5	PD5							Analog to digital converter ADC0, input channel number 5.
ADC0_CH6	PD6							Analog to digital converter ADC0, input channel number 6.

Alternate	LOCATION							
Functionality	0	1	2	3	4	5	6	Description
ADC0_CH7	PD7							Analog to digital converter ADC0, input channel number 7.
BOOT_RX	PE11							Bootloader RX.
BOOT_TX	PE10							Bootloader TX.
BU_STAT	PE3							Backup Power Domain status, whether or not the system is in backup mode
BU_VIN	PD8							Battery input for Backup Power Domain
BU_VOUT	PE2							Power output for Backup Power Domain
CMU_CLK0	PA2	PC12	PD7					Clock Management Unit, clock output number 0.
CMU_CLK1	PA1	PD8	PE12					Clock Management Unit, clock output number 1.
OPAMP_N0	PC5							Operational Amplifier 0 external negative input.
OPAMP_N1	PD7							Operational Amplifier 1 external negative input.
OPAMP_N2	PD3							Operational Amplifier 2 external negative input.
DAC0_OUT0 / OPAMP_OUT0	PB11							Digital to Analog Converter DAC0_OUT0 /OPAMP output channel number 0.
DAC0_OUT0ALT / OPAMP_OUT0ALT	PC0	PC1	PC2	PC3	PD0			Digital to Analog Converter DAC0_OUT0ALT / OPAMP alternative output for channel 0.
DAC0_OUT1 / OPAMP_OUT1	PB12							Digital to Analog Converter DAC0_OUT1 /OPAMP output channel number 1.
DAC0_OUT1ALT / OPAMP_OUT1ALT	PC12	PC13	PC14	PC15	PD1			Digital to Analog Converter DAC0_OUT1ALT / OPAMP alternative output for channel 1.
OPAMP_OUT2	PD5	PD0						Operational Amplifier 2 output.
OPAMP_P0	PC4							Operational Amplifier 0 external positive input.
OPAMP_P1	PD6							Operational Amplifier 1 external positive input.
OPAMP_P2	PD4							Operational Amplifier 2 external positive input.
DBG_SWCLK	PF0	PF0	PF0	PF0				Debug-interface Serial Wire clock input. Note that this function is enabled to pin out of reset, and has a built-in pull down.
DBG_SWDIO	PF1	PF1	PF1	PF1				Debug-interface Serial Wire data input / output. Note that this function is enabled to pin out of reset, and has a built-in pull up.
DBG_SWO	PF2		PD1	PD2				Debug-interface Serial Wire viewer Output. Note that this function is not enabled after reset, and must be enabled by software to be used.
EBI_A00	PA12	PA12	PA12					External Bus Interface (EBI) address output pin 00.
EBI_A01	PA13	PA13	PA13					External Bus Interface (EBI) address output pin 01.
EBI_A02	PA14	PA14	PA14					External Bus Interface (EBI) address output pin 02.
EBI_A03	PB9	PB9	PB9					External Bus Interface (EBI) address output pin 03.

5.12.3 GPIO Pinout Overview

The specific GPIO pins available in EFM32LG840 is shown in the following table. Each GPIO port is organized as 16-bit ports indicated by letters A through F, and the individual pin on this port is indicated by a number from 15 down to 0.

Table 5.36. GPIO Pinout

Port	Pin 15	Pin 14	Pin 13	Pin 12	Pin 11	Pin 10	Pin 9	Pin 8	Pin 7	Pin 6	Pin 5	Pin 4	Pin 3	Pin 2	Pin 1	Pin 0
Port A	PA15	PA14	PA13	PA12	—	—	—	—	—	PA6	PA5	PA4	PA3	PA2	PA1	PA0
Port B	—	PB14	PB13	PB12	PB11	—	—	PB8	PB7	PB6	PB5	PB4	PB3	—	—	—
Port C	PC15	PC14	PC13	PC12	—	—	—	—	PC7	PC6	PC5	PC4	—	—	—	—
Port D	—	—	—	—	—	—	—	PD8	PD7	PD6	PD5	PD4	PD3	PD2	PD1	PD0
Port E	PE15	PE14	PE13	PE12	PE11	PE10	PE9	PE8	PE7	PE6	PE5	PE4	—	—	—	—
Port F	—	—	—	—	—	—	—	—	—	—	PF5	PF4	PF3	PF2	PF1	PF0

5.12.4 Opamp Pinout Overview

The specific opamp terminals available in EFM32LG840 is shown in the following figure.

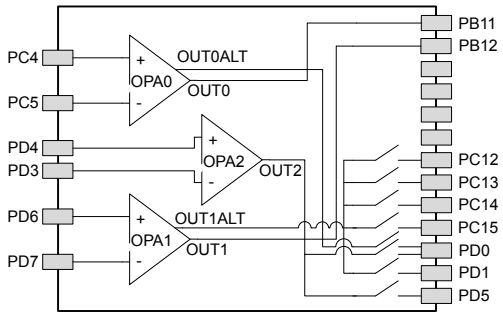

Figure 5.24. Opamp Pinout

Water Pads and Coordinates				Pad Alternative Functionality / Description				
Pad #	Pad Name	X (µm)	Y (µm)	Analog	EBI	Timers	Communica-tion	Other
47	AVDD_1	661.2	-2065.0	Analog power supply 1.				
48	AVSS_1	754.5	-2065.0	Analog ground 1.				
49	PB13	833.8	-2065.0	HFXTAL_P			US0_CLK #4/5 LEU0_TX #1	
50	PB14	919.6	-2065.0	HFXTAL_N			US0_CS #4/5 LEU0_RX #1	
51	IOVSS_3	1054.9	-2065.0	Digital IO ground 3.				
52	IOVDD_3	1151.7	-2065.0	Digital IO power supply 3.				
53	AVSS_0	1254.2	-2065.0	Analog ground 0.				
54	AVDD_0	1346.8	-2065.0	Analog power supply 0.				
55	PD0	1442.7	-2065.0	ADC0_CH0 DAC0_OUT0ALT #4/ OPAMP_OUT0 ALT OPAMP_OUT2 #1		PCNT2_S0IN #0	US1_TX #1	
56	PD1	1559.2	-2065.0	ADC0_CH1 DAC0_OUT1ALT #4/ OPAMP_OUT1 ALT		TIM0_CC0 #3 PCNT2_S1IN #0	US1_RX #1	DBG_SWO #2
57	PD2	1646.3	-2065.0	ADC0_CH2	EBI_A27 #0/1/2	TIM0_CC1 #3	USB_DMPU #0 US1_CLK #1	DBG_SWO #3
58	PD3	1749.3	-2065.0	ADC0_CH3 OPAMP_N2		TIM0_CC2 #3	US1_CS #1	ETM_TD1 #0/2
59	PD4	1851.4	-2065.0	ADC0_CH4 OPAMP_P2			LEU0_TX #0	ETM_TD2 #0/2
60	PD5	2065.0	-1872.9	ADC0_CH5 OPAMP_OUT2 #0			LEU0_RX #0	ETM_TD3 #0/2
61	PD6	2065.0	-1771.3	ADC0_CH6 OPAMP_P1		TIM1_CC0 #4 LETIM0_OUT0 #0 PCNT0_S0IN #3	US1_RX #2 I2C0_SDA #1	LES_ALTEX0 #0 ACMP0_O #2 ETM_TD0 #0
62	PD7	2065.0	-1669.4	ADC0_CH7 OPAMP_N1		TIM1_CC1 #4 LETIM0_OUT1 #0 PCNT0_S1IN #3	US1_TX #2 I2C0_SCL #1	CMU_CLK0 #2 LES_ALTEX1 #0 ACMP1_O #2 ETM_TCLK #0
63	PD8	2065.0	-1561.9	BU_VIN				CMU_CLK1 #1
64	PC6	2065.0	-1470.2	ACMP0_CH6	EBI_A05 #0/1/2		LEU1_TX #0 I2C0_SDA #2	LES_CH6 #0 ETM_TCLK #2
65	PC7	2065.0	-1385.2	ACMP0_CH7	EBI_A06 #0/1/2		LEU1_RX #0 I2C0_SCL #2	LES_CH7 #0 ETM_TD0 #2
66	VSS_DREG	2065.0	-1295.5	Ground for on-chip voltage regulator.				

Alternate	LOCATION							
Functionality	0	1	2	3	4	5	6	Description
LCD_SEG25	PF7							LCD segment line 25. Segments 24, 25, 26 and 27 are controlled by SEGEN6.
LCD_SEG26	PF8							LCD segment line 26. Segments 24, 25, 26 and 27 are controlled by SEGEN6.
LCD_SEG27	PF9							LCD segment line 27. Segments 24, 25, 26 and 27 are controlled by SEGEN6.
LCD_SEG28	PD9							LCD segment line 28. Segments 28, 29, 30 and 31 are controlled by SEGEN7.
LCD_SEG29	PD10							LCD segment line 29. Segments 28, 29, 30 and 31 are controlled by SEGEN7.
LCD_SEG30	PD11							LCD segment line 30. Segments 28, 29, 30 and 31 are controlled by SEGEN7.
LCD_SEG31	PD12							LCD segment line 31. Segments 28, 29, 30 and 31 are controlled by SEGEN7.
LCD_SEG32	PB0							LCD segment line 32. Segments 32, 33, 34 and 35 are controlled by SEGEN8.
LCD_SEG33	PB1							LCD segment line 33. Segments 32, 33, 34 and 35 are controlled by SEGEN8.
LCD_SEG34	PB2							LCD segment line 34. Segments 32, 33, 34 and 35 are controlled by SEGEN8.
LCD_SEG35	PA7							LCD segment line 35. Segments 32, 33, 34 and 35 are controlled by SEGEN8.
LCD_SEG36	PA8							LCD segment line 36. Segments 36, 37, 38 and 39 are controlled by SEGEN9.
LCD_SEG37	PA9							LCD segment line 37. Segments 36, 37, 38 and 39 are controlled by SEGEN9.
LCD_SEG38	PA10							LCD segment line 38. Segments 36, 37, 38 and 39 are controlled by SEGEN9.
LCD_SEG39	PA11							LCD segment line 39. Segments 36, 37, 38 and 39 are controlled by SEGEN9.
LES_ALTEX0	PD6							LESENSE alternate exite output 0.
LES_ALTEX1	PD7							LESENSE alternate exite output 1.
LES_ALTEX2	PA3							LESENSE alternate exite output 2.
LES_ALTEX3	PA4							LESENSE alternate exite output 3.
LES_ALTEX4	PA5							LESENSE alternate exite output 4.
LES_ALTEX5	PE11							LESENSE alternate exite output 5.
LES_ALTEX6	PE12							LESENSE alternate exite output 6.
LES_ALTEX7	PE13							LESENSE alternate exite output 7.
LES_CH0	PC0							LESENSE channel 0.
LES_CH1	PC1							LESENSE channel 1.
LES_CH2	PC2							LESENSE channel 2.
LES_CH3	PC3							LESENSE channel 3.

QFP64 Pin# and Name		Pin Alternate Functionality / Description			
Pin #	Pin Name	Analog	Timers	Communication	Other
53	PF12			USB_ID	
54	PF5	LCD_SEG3	TIM0_CDTI2 #2/5	USB_VBUSEN #0	PRS_CH2 #1
55	IOVDD_5	Digital IO power supply 5.			
56	VSS	Ground.			
57	PE8	LCD_SEG4	PCNT2_S0IN #1		PRS_CH3 #1
58	PE9	LCD_SEG5	PCNT2_S1IN #1		
59	PE10	LCD_SEG6	TIM1_CC0 #1	US0_TX #0	BOOT_TX
60	PE11	LCD_SEG7	TIM1_CC1 #1	US0_RX #0	LES_ALTEX5 #0 BOOT_RX
61	PE12	LCD_SEG8	TIM1_CC2 #1	US0_RX #3 US0_CLK #0 I2C0_SDA #6	CMU_CLK1 #2 LES_ALTEX6 #0
62	PE13	LCD_SEG9		US0_TX #3 US0_CS #0 I2C0_SCL #6	LES_ALTEX7 #0 ACMP0_O #0 GPIO_EM4WU5
63	PE14	LCD_SEG10	TIM3_CC0 #0	LEU0_TX #2	
64	PE15	LCD_SEG11	TIM3_CC1 #0	LEU0_RX #2	

Alternate	LOCATION							
Functionality	0	1	2	3	4	5	6	Description
US1_TX		PD0	PD7					USART1 Asynchronous Transmit.Also used as receive input in half duplex communication. USART1 Synchronous mode Master Output / Slave Input (MOSI).
US2_CLK	PC4	PB5						USART2 clock input / output.
US2_CS	PC5	PB6						USART2 chip select input / output.
US2_RX		PB4						USART2 Asynchronous Receive. USART2 Synchronous mode Master Input / Slave Output (MISO).
US2_TX		PB3						USART2 Asynchronous Transmit.Also used as receive input in half duplex communication. USART2 Synchronous mode Master Output / Slave Input (MOSI).
USB_DM	PF10							USB D- pin.
USB_DMPU	PD2							USB D- Pullup control.
USB_DP	PF11							USB D+ pin.
USB_ID	PF12							USB ID pin. Used in OTG mode.
USB_VBUS	USB_VBUS							USB 5 V VBUS input.
USB_VBUSEN	PF5							USB 5 V VBUS enable.
USB_VREGI	USB_VREGI							USB Input to internal 3.3 V regulator
USB_VREGO	USB_VREGO							USB Decoupling for internal 3.3 V USB regulator and regulator output

5.19.3 GPIO Pinout Overview

The specific GPIO pins available in EFM32LG942 is shown in the following table. Each GPIO port is organized as 16-bit ports indicated by letters A through F, and the individual pin on this port is indicated by a number from 15 down to 0.

Table 5.57. GPIO Pinout

Port	Pin 15	Pin 14	Pin 13	Pin 12	Pin 11	Pin 10	Pin 9	Pin 8	Pin 7	Pin 6	Pin 5	Pin 4	Pin 3	Pin 2	Pin 1	Pin 0
Port A	—	PA14	PA13	PA12	—	—	—	—	—	—	PA5	PA4	PA3	PA2	PA1	PA0
Port B	—	PB14	PB13	—	PB11	—	—	PB8	PB7	PB6	PB5	PB4	PB3	—	—	—
Port C	—	—	—	—	—	—	—	—	PC7	PC6	PC5	PC4	—	—	—	—
Port D	—	—	—	—	—	—	—	PD8	PD7	PD6	PD5	PD4	PD3	PD2	PD1	PD0
Port E	PE15	PE14	PE13	PE12	PE11	PE10	PE9	PE8	PE7	PE6	PE5	PE4	—	—	—	—
Port F	—	—	—	PF12	PF11	PF10	—	—	—	—	PF5	—	—	PF2	PF1	PF0

LQFP100 Pin# and Name		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	EBI	Timers	Communication	Other
24	PB7	LFXTAL_P		TIM1_CC0 #3	US0_TX #4 US1_CLK #0	
25	PB8	LFXTAL_N		TIM1_CC1 #3	US0_RX #4 US1_CS #0	
26	PA7	LCD_SEG35	EBI_CSTFT #0/1/2			
27	PA8	LCD_SEG36	EBI_DCLK #0/1/2	TIM2_CC0 #0		
28	PA9	LCD_SEG37	EBI_DTEN #0/1/2	TIM2_CC1 #0		
29	PA10	LCD_SEG38	EBI_VSNC #0/1/2	TIM2_CC2 #0		
30	PA11	LCD_SEG39	EBI_HSNC #0/1/2			
31	IOVDD_2	Digital IO power supply 2.				
32	VSS	Ground.				
33	PA12	LCD_BCAP_P	EBI_A00 #0/1/2	TIM2_CC0 #1		
34	PA13	LCD_BCAP_N	EBI_A01 #0/1/2	TIM2_CC1 #1		
35	PA14	LCD_BEXT	EBI_A02 #0/1/2	TIM2_CC2 #1		
36	RESETn	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.				
37	PB9		EBI_A03 #0/1/2		U1_TX #2	
38	PB10		EBI_A04 #0/1/2		U1_RX #2	
39	PB11	DAC0_OUT0 / OPAMP_OUT0		TIM1_CC2 #3 LE-TIM0_OUT0 #1	I2C1_SDA #1	
40	PB12	DAC0_OUT1 / OPAMP_OUT1		LETIM0_OUT1 #1	I2C1_SCL #1	
41	AVDD_1	Analog power supply 1.				
42	PB13	HFXTAL_P			US0_CLK #4/5 LEU0_TX #1	
43	PB14	HFXTAL_N			US0_CS #4/5 LEU0_RX #1	
44	IOVDD_3	Digital IO power supply 3.				
45	AVDD_0	Analog power supply 0.				
46	PD0	ADC0_CH0 DAC0_OUT0ALT #4/ OPAMP_OUT0ALT OPAMP_OUT2 #1		PCNT2_S0IN #0	US1_TX #1	
47	PD1	ADC0_CH1 DAC0_OUT1ALT #4/ OPAMP_OUT1ALT		TIM0_CC0 #3 PCNT2_S1IN #0	US1_RX #1	DBG_SWO #2
48	PD2	ADC0_CH2	EBI_A27 #0/1/2	TIM0_CC1 #3	USB_DMPU #0 US1_CLK #1	DBG_SWO #3
49	PD3	ADC0_CH3 OPAMP_N2		TIM0_CC2 #3	US1_CS #1	ETM_TD1 #0/2

Alternate	LOCATION							
Functionality	0	1	2	3	4	5	6	Description
EBI_AD09	PA0	PA0	PA0					External Bus Interface (EBI) address and data input / output pin 09.
EBI_AD10	PA1	PA1	PA1					External Bus Interface (EBI) address and data input / output pin 10.
EBI_AD11	PA2	PA2	PA2					External Bus Interface (EBI) address and data input / output pin 11.
EBI_AD12	PA3	PA3	PA3					External Bus Interface (EBI) address and data input / output pin 12.
EBI_AD13	PA4	PA4	PA4					External Bus Interface (EBI) address and data input / output pin 13.
EBI_AD14	PA5	PA5	PA5					External Bus Interface (EBI) address and data input / output pin 14.
EBI_AD15	PA6	PA6	PA6					External Bus Interface (EBI) address and data input / output pin 15.
EBI_ALE	PF3	PC11	PC11					External Bus Interface (EBI) Address Latch Enable output.
EBI_ARDY	PF2	PF2	PF2					External Bus Interface (EBI) Hardware Ready Control input.
EBI_BL0	PF6	PF6	PF6					External Bus Interface (EBI) Byte Lane/Enable pin 0.
EBI_BL1	PF7	PF7	PF7					External Bus Interface (EBI) Byte Lane/Enable pin 1.
EBI_CS0	PD9	PD9	PD9					External Bus Interface (EBI) Chip Select output 0.
EBI_CS1	PD10	PD10	PD10					External Bus Interface (EBI) Chip Select output 1.
EBI_CS2	PD11	PD11	PD11					External Bus Interface (EBI) Chip Select output 2.
EBI_CS3	PD12	PD12	PD12					External Bus Interface (EBI) Chip Select output 3.
EBI_CSTFT	PA7	PA7	PA7					External Bus Interface (EBI) Chip Select output TFT.
EBI_DCLK	PA8	PA8	PA8					External Bus Interface (EBI) TFT Dot Clock pin.
EBI_DTEN	PA9	PA9	PA9					External Bus Interface (EBI) TFT Data Enable pin.
EBI_HSNC	PA11	PA11	PA11					External Bus Interface (EBI) TFT Horizontal Synchronization pin.
EBI_NANDREn	PC3	PC3	PC3					External Bus Interface (EBI) NAND Read Enable output.
EBI_NANDWEn	PC5	PC5	PC5					External Bus Interface (EBI) NAND Write Enable output.
EBI_REn	PF5	PF9	PF5					External Bus Interface (EBI) Read Enable output.
EBI_VSNC	PA10	PA10	PA10					External Bus Interface (EBI) TFT Vertical Synchronization pin.
EBI_WEn	PF4	PF8	PF4					External Bus Interface (EBI) Write Enable output.
ETM_TCLK	PD7	PF8	PC6	PA6				Embedded Trace Module ETM clock .
ETM_TD0	PD6	PF9	PC7	PA2				Embedded Trace Module ETM data 0.
ETM_TD1	PD3	PD13	PD3	PA3				Embedded Trace Module ETM data 1.

14.4 Revision 1.21

November 21st, 2013

This revision applies the following devices:

- EFM32LG230
- EFM32LG232
- EFM32LG280
- EFM32LG290
- EFM32LG295
- EFM32LG330
- EFM32LG332
- EFM32LG380
- EFM32LG390
- EFM32LG395
- EFM32LG840
- EFM32LG842
- EFM32LG880
- EFM32LG890
- EFM32LG895
- EFM32LG940
- EFM32LG942
- EFM32LG980
- EFM32LG990
- EFM32LG995

Updated figures.

Updated errata-link.

Updated chip marking.

Added link to Environmental and Quality information.

For devices with a DAC, re-added missing DAC-data.